

## C1206C224M1REC7210

ESD SMD Comm X7R, Ceramic, 0.22 uF, 20%, 100 VDC, X7R, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II, 1206



Click here for the 3D model.

Dimensions		
Chip Size	1206	
L	3.2mm +/-0.2mm	
W	1.6mm +/-0.2mm	
Т	0.9mm +/-0.10mm	
В	0.5mm +/-0.25mm	

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	10000

General Information	
Series	ESD SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

Specifications				
Capacitance	0.22 uF			
Measurement Condition	1 kHz 1.0Vrms			
Capacitance Tolerance	20%			
Voltage DC	100 VDC			
ESD Level per AEC-Q200	25,000 V ESD Level			
Dielectric Withstanding Voltage	250 VDC			
Temperature Range	-55/+125°C			
Temperature Coefficient	X7R			
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms			
Dissipation Factor	2.5%1kHz1.0Vrms			
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours			
Insulation Resistance	4.5455 GOhms			

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